

### Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with \* are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo					
Company name *	Lenovo						
Contact information *	Lenovo Global Environmental Affairs		Lenovo				
e-mail address	Alvin L Carter						
	alcarter@lenovo.com						
Internet site *	https://www.lenovo.com/us/en/about/sustainability						
Additional information	The latest version of this document can be found at:						
	http://www.lenovo.com/ecodeclaration	ttp://www.lenovo.com/ecodeclaration					

	The company declares (based on product specification or test results based obtained from sample testing), that the product					
conforms to the stateme	ents given in this declaration.					
Type of product *	Type of product * SERVER					
Commercial name *	Lenovo ThinkSystem SR670					
Model number *	7Y36, 7Y37, 7Y38					
Issue date *	2020-02-13					
Intended market *	🔀 Global 📃 Europe 🗌 Asia, Pacific & Japan 🗌 Americas 🗌 Other					
Additional information						

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

#### About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products.

mouch	umber *	7Y36, 7Y37, 7Y38 Logo					
Issue date *		2020-02-13	Leng	Lenovo,			
Produc	t environ	mental attributes - Legal requirements	Require	men	t met		
Item			Yes	No	N/A		
P1		bus substances and preparations					
P1.1*	Product	s do comply with current European RoHS Directive. (See legal reference and NOTE B1)	$\boxtimes$				
P1.2*		s do not contain Asbestos (see legal reference). nt: Legal reference has no maximum concentration value.	$\square$				
P1.3*	hydrobro trichloro	s do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), pmofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1- ethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum ration values.					
P1.4*	Product	s do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polychlorinated /l (PCT) in preparations (see legal reference).	$\boxtimes$				
P1.5*	Product	s do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	ne 🔀				
P1.6*	(see leg	th direct and prolonged skin contact do not release nickel in concentrations above 0,5 μg/cm²/wee al reference). nt: Max limit in legal reference when tested according to EN1811:2011-5.	k 🔀				
P1.7*	REACH	Article 33 information about substances in articles is available at (add URL or mail contact): ww.lenovo.com/us/en/sustainability-resources	$\boxtimes$				
P2	Batterie	S					
P2.1*	If the product contains a battery or an accumulator, the battery/accumulator is labeled with the disposal symbol. Information on proper disposal is provided in user manual. (See legal reference)						
P2.2*		s or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See lega	al 🔀				
P2.3*	Batterie	s and accumulators are readily removable. (See legal reference)	$\mathbf{X}$				
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See legal reference		Ē			
P2.5*		ternal batteries of a notebook computer cannot be "accessed and replaced by a nonprofessional e related text is present and legible on the external packaging (see legal reference)					
P3		nity verification & Eco design (ErP)					
P3.1*	The pro	duct is CE-marked to show conformance with applicable legal requirements (see legal reference). claration of Conformity can be requested at: https://www.lenovo.com/us/en/compliance/eu-doc	$\boxtimes$				
P3.2*	The pro	duct complies with the Eco design requirements for energy-related products, all reference).	$\boxtimes$				
	Require	d information is; given in item P15 or added to this document, available at: https://www.lenovo.com/us/en/compliance/eco-declaration					
P5	Product	packaging					
P5.1*	Packagi	ng and packaging components do not contain more than 0,01% lead, mercury, cadmium an ent chromium by weight of these together.	nd 🔀				
P5.2*	The pac	kaging materials are marked with abbreviations and numbers indicating the nature of the material ( se legal reference).	(s) 🔀				
P5.3*	The product packaging material is free from ozone depleting substances as specified in the Montreal Protocol (see legal reference). Comment: Legal reference has no maximum concentration values.						
P6	Treatme	nt information					
FU							

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model nu	imber *	7Y36, 7Y37, 7Y38	Logo			
Issue dat	te *	2020-02-13		Len	ovo	D
Product		mental attributes - Market requirements (See General NOTE GN	below)			
		onmental conscious design		Require		
Item <b>P7</b>		tory to fill in. Additional information regarding each item may be found under P14. <b>Disassembly, recycling</b>		Yes	No	N/A
P7.1*	Parts the	at have to be treated separately are easily separable				
P7.2*		naterials in covers/housing have no surface coating.			╞	
P7.3*		arts > 100 g consist of one material or of easily separable materials.			╞	╞
P7.4*		arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.			╞	╞
P7.5		arts are free from metal inlays or have inlays that can be removed with commonly	available tools		╞	
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).			╞	╞
17.0	Product					
P7.7*		ng can be done e.g. with processor, memory, cards or drives				
P7.8*		ng can be done using commonly available tools			+	╶┝┤╴
P7.9		arts are available after end of production for: years				╶┼┤
P7.10		is available after end of production for: years				
17.10		and substance requirements				
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum):				
			ial type:			
P7.12		n materials of external electrical cables are PVC free.			$\boxtimes$	
P7.13	Insulation	n materials of internal electrical cables are PVC free.				
P7.14	weight (*	plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm)   1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flam chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine	ne retardants, a	nd		
		an 25% post-consumer recycled content.		.9		
P7.15		circuit boards, PCBs (without components) are low halogen: all $\Box$ PCBs > 25 g $\Box$ ed in IEC 61249-2-21. (See <sup>5</sup> NOTE B2)	are low halog	en		
P7.16	Flame re Marking:	etarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4				
P7.17		nemical specifications of flame retardants in printed circuit boards > 25 g (without o	components):			
	TBBPA (	(additive) 🛄, TBBPA (reactive) 🔛 (See NOTE B3), Other: chemical name:	, CAS #:			
		nemical specifications of flame retardants in printed circuit boards (without compor g ISO 1043-4:	ients) > 25 g			
P7.18		ame retarded plastic parts > 25 g contain the following flame retardant substanc rations above 0,1%:	es/preparations	in		
		ical name: , CAS #: (See NOTE B4)				
	2. Chem	ical name: , CAS #: "				
	3. Chem	ical name: , CAS #: "				
	<u>Alt. 2: </u> Ch	nemical specifications of flame retardants in plastic parts > 25 g according ISO 104	13-4:			
P7.19	In plastic	parts > 25 g, flame retardant substances/preparations above 0,1% are used whic	h have been			
	assigned	the following Risk phrases; and Hazard statements:				
			See note B5)			
P7.20*	Postcons	sumer recycled plastic material content is used in the product (See Note B6):			$\boxtimes$	
	a) Oft ape or	at least one of the two alternatives below shall be answered; total plastic parts' weight > 25 g, the postconsumer recycled plastic material content ercentage of total plastic by weight) is %.	nt (calculated as	;		

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7Y36, 7Y37, 7Y38	Logo	
Issue date *	2020-02-13		Lenovo
Product environment	nental attributes - Market requirements (continued)		Requirement met

Requirement metYesNoN/A

	Material and substance requirements (continued)									
P7.21*		material content is used		DTE B7):						
	If YES; at least one of the two alternatives below shall be answered; a) Of total plastic parts' weight > 25 g, the biobased plastic material content (calculated as a percentage of total plastic by weight) is %. or									
	b) The weight	of the biobased plastic n	naterial is g.							
P7.22*	0	e free from mercury, i.e. l d specify: Number of lam		Im mercury content pe	r lamp: mg					
P7.23*	If product includes an integral display, the total mercury content in the integrated display: mg									
P8	Batteries				· -					
P8.1*	Battery chemica	I composition: Lithium M	langanese Dioxide							
P9		nption (See NOTE B8)								
P9.1		he following power levels								
Energy mo	de *	Power level at <b>100</b> V AC	Power level at 115 V AC	Power level at 230 V AC	Reference/Standard modes and test metho		$\square$			
Peak (On-I	max)	W	W	W	Full load					
Category	y									
EPS No-loa	ad	W	W	W						
charger plu	ower supply / igged in the wall lisconnected from t )									
PTEC *		W	W	W			$\square$			
Typical Ene	ergy Consumptior	1								
ETEC * Annual Ene	ergy Consumption	kWh/year	kWh/year	kWh/year			$\boxtimes$			
		ency Level (International	Efficiency Marking Pro	tocol) * :			X			
Display res	olution * :	megapixels					$\boxtimes$			
Default time	e to enter energy	save mode: minut	es							
P9.2*	Information about	ut the energy save function	on is provided with the	product.	1					
P9.3	Energy efficienc	y class (monitors only):					X			
P10	Emissions	- Declared according to	ISO 9296 (See NOTE	B0)	•					
P10.1	Mode	Mode description	100 0200 (000 11012		A-weighted sound pow	er level. / wa	(B)			
	Idle	* Indicates idle conditi	ion (system is	* 6.7	in noighted country port	or roron, 200,				
		powered on, but no di	sk activity and all							
	other devices idling)           Operation         * Indicates CPU and memory operating         * 7.3									
	condition(run PTU with 50% TDP to stress									
	CPU and memory subsystem									
	Other mode Declared A-weighted sound pressure level (dB) L <sub>pAm</sub>									
	Other mode	Declared A-weighted sound	d pressure level (dB) $L_{pAm}$							
	Measured according to: ISO 7779 ECMA-74									
	Other (only if not covered by ECMA-74)									
P10.4	Electromagnetic emissions           Computer display meets the requirement for low frequency electromagnetic fields of the following voluntary									
т то. <del>т</del>	program(s):									

Item

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available; see <a href="http://www.ecma-international.org/publications/standards/Ecma-370.htm">http://www.ecma-international.org/publications/standards/Ecma-370.htm</a>

NOTE B9 A Guidance document on Acoustic Noise is available;

see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model nu	umber *	7Y36, 7Y37, 7	Y38		1	Logo			
Issue da	te *	2020-02-13				Leno	Lenovo		
Product	t environr	nental attribu	tes - Market requiremen	ts (continued)			Require	ment	met
Item							Yes	No	N/A
P12		mics for compu							
P12.1*	The disp	olay meets the e	rgonomic requirements of ISC	O 9241-307 for visual	display technologi	es.			$\boxtimes$
P12.2*	The phy	sical input devic	e meets the requirements of	ISO 9995 and ISO 924	41-410.				$\boxtimes$
P13	Packagi	ing and docum	entation						
P13.1*	Product packaging material type(s): <i>Paper - Corrugated Double wall</i> weight (kg): <i>3.85</i> Product packaging material type(s): <i>Plastic - Laminated (Fabricated) EPE</i> weight (kg): <i>2.04</i> Product packaging material type(s): <i>Plastic - HDPE (high density polyethylene)</i> weight (kg): <i>0.4</i> Product packaging material type(s): <i>Plastic - PP (polypropylene)</i> weight (kg): <i>0.075</i>								
P13.2*			backaging is free from PVC.		0 (0)		$\boxtimes$		
P13.3*		duct primary con er recovered fibe	rrugated fiberboard packagir er content: <b>25</b> %	ng, specify the contai	ned percentage o	of minimum p	post-		
P13.4*		media for user a ronic, XPaper,	nd product documentation (ti	ck box):					
P13.5	Ùser and	<i>,</i> ,	nis item if paper documentation nentation on paper media is c	,					
	,	hlorine-free al chlorine-free							
	Process	ed chlorine-free							
P14	Volunta	ry programs							
P14.1	The proc	duct meets the r	equirements of the following	voluntary program(s):					
	ENERG Eco-labe Eco-labe		Criteria version: Criteria version: Criteria version:	Date: Date: Date:	Product ca Product ca Product ca	ategory:			
P15	Additio	nal information	(See NOTE B10)						
P9			f computer products; desc						
	NOTE: Supplier makes no representations, guarantees, assurances or warranties whether express or implied, regarding the information contained in this document. All information provided by supplier in this document is provided based on supplier's knowledge available at the time of completion, and supplier shall have no obligation to update such information. The information provided here is approximate and provided for informational purposes only. See a Lenovo Account Representative for more information.								
P9			fied Enterprise Servers for a r.gov/products/data_center						

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

## Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

# Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

#### Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

#### **SERVERS**

### General information

Commercial name (3.1 (b))	Lenovo ThinkSystem SR670	Logo
Contact Address (3.1 (b))	7001 Development Dr. Building 7, Morrisville, NC 27560	
	United States	Lenovo
Model Number (3.1 (c))	7Y36, 7Y37, 7Y38	Lenovo.
Issue Date	2020-02-13	
Additional information		

Product e	environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3							
1.a	Is the product consider to be in scope of ErP Lot 9 🛛 🔀 in scope 🗌 out of scope, product is out of scope as:							
1.b (3.1 (a))	Server type 🛛 Rack Server 🔄 High Performance Computing (HPC)							
(0.1 (a))	Tower Server Multi Node Server							
1 -	Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section							
1.c (3.1 (d))	Year of manufacture: 2020							
1.d (3.1 (p))	Product model part of a server product family? 🛛 🗌 No 🔀 Yes							
(0.1 (p))	List of all model configurations that are represented by the model: https://lenovopress.com/lp0923-thinksystem-sr670-server-xeon-sp-gen-1;https://lenovopress.com/lp1051-lenovo-							
	thinksystem-sr670-server-xeon-sp-gen-2							
1.e	Information on the secure data deletion functionality							
(3.1 (n))	(a) instructions on how to use the functionality:							
	2 methods are provided to use the functionality.							
	<ol> <li>Use a command line tool to do the secure data deletion on the remote target system via boot up a customized Linux OS on it.</li> </ol>							
	Eg: OneCli.exe serase –bmc USERID:PASSWORD@xx.xx.xx.xxsftp root:password@xx.xxx.xx.xx:/home –log 5							
	2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu.							
	(b) techniques used: OS tools under Linux -> Standard Linux Open Source tool							
	(c) supported secure data deletion standard (if any):							
	Secure Erase/block Erase/Crypto Erase, Sanitize							
	<b>OR -</b> Reference to other information: Hdparm: <u>https://en.wikipedia.org/wiki/Hdparm</u>							
	Nvme-format: https://www.mankier.com/1/nvme-format							
	sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/							
	scrub: https://www.systutorials.com/docs/linux/man/1-scrub/							
	storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-iles/StorCLI_RefMan_revf.pdf							
1.f (3.1 (o))	Blade servers? 🛛 🛛 No 📃 Yes							
,,	list of recommended combinations with compatible chassis:							
2.a	g Data Indicative weight range at component level, of the (a) Cobalt in the batteries (b) Neodymium in the HDDs							
(3.3 (a))	following critical raw materials: $(a)$ Cobart in the batteries $(b)$ Neodymium in the HDDs $(a)$ cobart in the batteries $(b)$ Neodymium in the HDDs							
	between 5 g and 25 g							
	above 25 g							
2.b	Instructions on the disassembly operations							
(3.3 (b))	<ul> <li>(a) the type of operation;</li> <li>(b) the type and number of fastening technique(s) to be unlocked;</li> </ul>							
	(c) the tool(s) required.							
	OR - Reference to other information: https://thinksystem.lenovofiles.com/help/topic/7Y37/sr670_maintenance_manual.pdf							
2.c	Firmware Reference to information on last available firmware:							
	https://datacentersupport.lenovo.com/cn/en/products/servers/thinksystem/sr670/7y36/downloads/driver-list/							
Additional	information							

## Server family specific information Family 1

Family I	no. / name	🛛 1 - 2 CPU popula	ted famil	ly		
<b>Model n</b> (3.1 (c) )	number(s) / Description	Standard or low-end performance configuration: Processor: Intel Xeon Silver 411, Storage: 1TB HDD * 2, Memory: 16GB * 12, PSU: 2000W * 2 High-end performance configuration: Processor: Intel Xeon Platinum 8280L, Storage: 480GB SSD * 2, Memory: 16GB * 24, PSU: 2000W * 2				
Additional information You can refer to https://www.plugloadsolutions.com/80PlusPo https://lenovopress.com/lp0923-thinksystem- 1;https://lenovopress.com/lp1051-lenovo-thin efficiency details.					-xeon-sp-gen-	
	t environmental attri					
F1.a (3.1 (e))						
	700-014265-1500 10% <b>92.59</b> 20% <b>94</b> DPS-2000HB A	performance configural <b>1.8</b> 50% <b>95.3</b> 100% <b>1.4</b> 50% <b>94.5</b> 100%	93.3 Av	0		
	High-end performand 700-014265-1500 10% 92.5 20% 94. DPS-2000HB A 10% 91.6 20% 93.	ce configuration(s): 8 50% 95.3 100% 9	<b>3.3</b> Ave	-		
F1.b (3.1 (f))		of the rated load level		standard or low-end performation configuration: 1.000	nce high-end performance configuration: 1.000	
F1.c (3.1 (g))	PSU rated power out (in Watts rounded to	tput		standard or low-end performatic configuration: 2000		
	<b>internal note:</b> If a product model is part of a ser product family shall be reported v	ver product family, all PSUs offered ir vith the information specified in (e) an	n a server nd (f)			
F1.d (3.1 (h))	idle state power (in Watts and rounde	d to the first decimal pla	ace)	standard or low-end performation: <b>79.5</b>	nce high-end performance configuration: <b>133.2</b>	
F1.e		ts for additional idle pov				
(3.1 (i))			andard or onfiguratio	low-end performance n:	high-end performance configuration:	
	CPU Performance		-	et (10 × PerfCPU W) et (7 × PerfCPU W)	1 Socket 2 Socket	
ces adjustments esting	Additional PSU		es #: 1	<b>X Y</b>	Yes #: 1	
stme	HDD		es #: 2		No #: 0	
dju	SDD Additional memory		o #: 0 es #: 1560		Yes #: 2 Yes #: 380GB	
rces ad testing	Additional buffered DDF		o #: 0	30	No #: 0	
ance	Additional I/O devices		none		none	
low:			<b>i</b>	No Allowance	<pre></pre>	
du				2,0 W/Active Port	= 1 Gb/s: 2.0 W/Active Port	
idle power allowanc during te			-	nd < 10 Gb/s: 4,0 W/Active Port		
le p			<b>i</b>		> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port	
ē				and < 25Gb/s: 15,0 W/Active Port	$\geq$ 10 Gb/s and < 25Gb/s: 15,0 W/Active Port	
			-	and < 50Gb/s: 20,0 W/Active Port	$\geq$ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port	
F1.f	movimum power		_ 2 50 Gb/s	26,0 W/Active Port standard or low-end performa	≥ 50 Gb/s 26,0 W/Active Port	
(3.1 (j))	maximum power (in Watts and rounde	d to the first decimal pla	ace)	configuration: <b>127</b>	configuration: 483	
F1.g (3.1 (k))	operating condition c (as defined in Table			standard or low-end performan configuration: A1 A2 A3 A4	nce high-end performance configuration: A1 A2 A3 XA4	
				Exception comments	Exception comments	
F1.h (3.1 (l))	-	e higher boundary temp ating condition class (in	•	standard or low-end performation configuration: 88.4	nce high-end performance configuration: 140.8	
F1.i (3.1 (m))		ency and the performan		standard or low-end performan configuration: 24.8		